© Copyright	Composition De 2005. IPC, Bannock and Pan-American c	burn, Illinois. A	ll rights reserved ations.	under both	This docume level parts, t	ent is a declarat	ion of the su	ibstances s all lowe	within the manufac r level materials for	cturer listed	d item. No e manufact	ote: if the turer has	item is an asso engineering re	embly with low sponsibility.	
	IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				*	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi					als and Mfg Information				
Supplier Information															
Company name*	Company unique ID				Unique ID Authority					Response Date*					
nsemi											2024-05-17				
Contact Name	Title - Contac	Title - Contact			Phone - Contact*					Email - Contact*					
Product-Env-Stewards	Product Enviro Compliance				NA				Prod	Product-Env-Stewards@onsemi.com					
uthorized Representative*	Title - Representative				Phone - Representative*				Email	Email - Representative*					
Product-Env-Stewards	Product Enviro Compliance				NA				Prod	Product-Env-Stewards@onsemi.com					
Requester Item Number	Requester Item Number Mfr Item		n Number Mfr Item Name			Effective Date	Version	Version Manufacturing Site			Weight*	k	UOM	Unit Type	
	MC74V 5G-L22	C74VHC1G125P5T Non-Inverting 3-Stat G-L22088		State Buffer		2024-05-17)5-17						mg	Each	
Aanufacturing Proccess Inf	formation														
Terminal Plating / Grid A	Plating / Grid Array Material Terminal Base Alle		Alloy	J-STD-020 MSL Rating		Peak Process Body Temperature Max Time at Peal		ak Tempe	rature N	umber of	Reflow Cycle	es			
Matte Tin (Sn) - annealed CU Alloy		CU Alloy	1			260 C		С	30	sec	onds 3				
omments															
vel 1 - maximum time at peak ter	nperature during so	dering is 10-3) seconds												
or more information regarding m	naterial composition	please refer to	page 3												

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		nium (Cr6+), Polybro	ominated Biphenyls (PBB), Polybron	dmium and quantity limit of 0.1% by mass (100 minated Diphenyl Ethers (PBDE), and Bis(2-eth						
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of					
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted					
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.										
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.										
Supplier Digital Signature Ra	stislav Drska	Le								

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3

sigma range of distribution unless	otherwise noted).				-			
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.03	mg	Supplier	Silicon (Si)	7440-21-3		0.03	mg
Lead Frame	0.52	mg	Supplier	Silver (Ag)	7440-22-4		0.0926	mg
			В	Nickel (Ni)	7440-02-0		0.1607	mg
			Supplier	Iron (Fe)	7439-89-6		0.222	mg
			Supplier	Copper (Cu)	7440-50-8		0.0447	mg
Mold Compound-Black	0.6	mg	Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.06	mg
			Supplier	Carbon Black (C)	1333-86-4		0.003	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.087	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		0.39	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.06	mg
Plating	0.02	mg	Supplier	Tin (Sn)	7440-31-5		0.02	mg
Wire Bond - Au	0.02	mg	Supplier	Gold (Au)	7440-57-5		0.02	mg